

Electronic Patent Application Fee Transmittal

Application Number:	10591580
Filing Date:	05-Sep-2006
Title of Invention:	Heat-resistant resin laminated film, multilayer film with metal layer including same and semiconductor device
First Named Inventor/Applicant Name:	Takuo Watanabe
Filer:	Deborah Sue Gladstein/Gail Frohnert
Attorney Docket Number:	358682001300

Filed as Large Entity

U.S. National Stage under 35 USC 371 Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
-------------	----------	----------	--------	----------------------

Basic Filing:

Pages:

Claims:

Miscellaneous-Filing:

Petition:

Patent-Appeals-and-Interference:

Post-Allowance-and-Post-Issuance:

Extension-of-Time:

Extension - 2 months with \$0 paid	1252	1	460	460
------------------------------------	------	---	-----	-----

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				460